SPECIFICATIONS FOR UV LED NICHIA CORPORATION

NCSU033B(T)

- Pb-free Reflow Soldering Application
- Built-in ESD Protection Device
 RoHS Compliant



SPECIFICATIONS

(1) Absolute Maximum Ratings

Item	Symbol	Absolute Maximum Rating	Unit
Forward Current	${ m I}_{\sf F}$	700	mA
Pulse Forward Current	${ m I}_{\sf FP}$	1000	mA
Allowable Reverse Current	I_R	85	mA
Power Dissipation	P_{D}	3.08	W
Operating Temperature	T_{opr}	-10~85	°C
Storage Temperature	T_{stq}	-40~100	°C
Junction Temperature	T _J	130	°C

^{*} Absolute Maximum Ratings at $T_S=25$ °C.

(2) Initial Electrical/Optical Characteristics

Item	Symbol	Condition	Тур	Unit
Forward Voltage	V_{F}	I _F =500mA	3.8	V
Radiant Flux	Фе	I _F =500mA	325	mW
Peak Wavelength	λp	I _F =500mA	365	nm
Spectrum Half Width	Δλ	I _F =500mA	9.0	nm

^{*} Characteristics at T_S =25°C.

^{*} I_{FP} conditions with pulse width $\leq 10 \text{ms}$ and duty cycle $\leq 10 \%$.

^{*} Radiant Flux value as per CIE 127:2007 standard.

st For stabilizing the LED characteristics, it is recommended to operate at greater than 10% nominal current.

RANKS

Item	Rank	Min	Max	Unit
	Н	4.0	4.4	
Forward Voltage	М	3.6	4.0	V
	L	3.2	3.6	
	P9	350	390	
Radiant Flux	P8	310	350	mW
	P7	270	310	
Peak Wavelength	Ua	360	370	nm

- * Ranking at $T_s=25$ °C.
- * Tolerance of measurements of the Forward Voltage is ± 0.05 V.
- * Tolerance of measurements of the Radiant Flux is $\pm 10\%$.
- * Tolerance of measurements of the Peak Wavelength is ± 3 nm.
- * A shipment shall consist of LEDs in a combination of the above ranks.

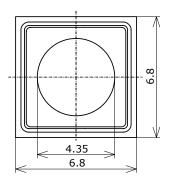
 The percentage of each rank in the shipment shall be determined by Nichia.

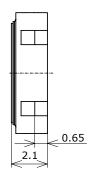
OUTLINE DIMENSIONS

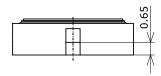
* 本製品はRoHS指令に適合しております。
This product complies with RoHS Directive.

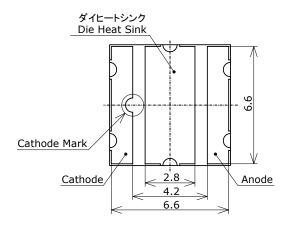
NCSU033x 管理番号 No. STS-DA7-0454A

(単位 Unit: mm, 公差 Tolerance: ±0.2)







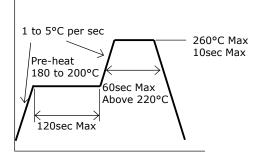




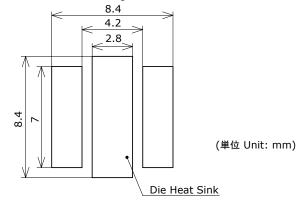
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	\Protection Device

SOLDERING

• Recommended Reflow Soldering Condition(Lead-free Solder)



• Recommended Soldering Pad Pattern

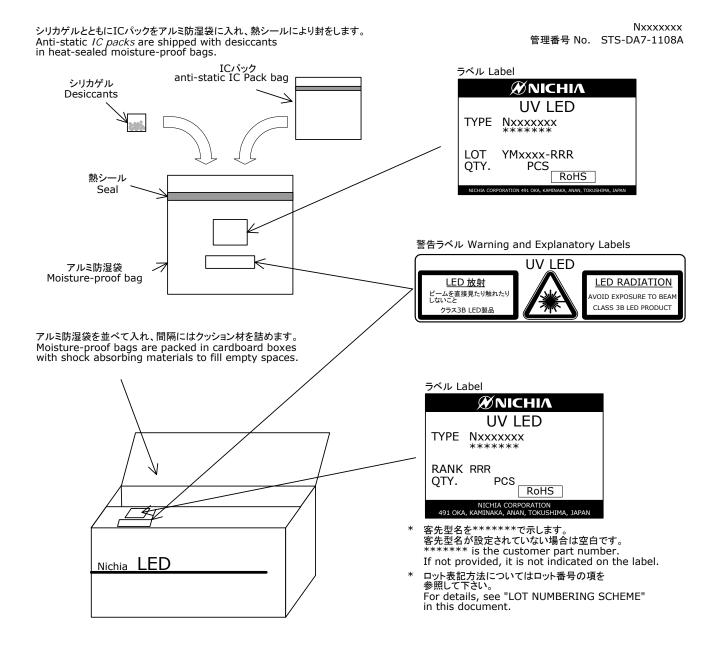


- * This LED is designed to be reflow soldered on to a PCB. If dip soldered or hand soldered, Nichia cannot guarantee its reliability.
- * Reflow soldering must not be performed more than twice.
- * Avoid rapid cooling. Ramp down the temperature gradually from the peak temperature.
- * Nitrogen reflow soldering is recommended. Air flow soldering conditions can cause optical degradation, caused by heat and/or atmosphere.
- * Repairing should not be done after the LEDs have been soldered.

 It should be confirmed beforehand whether the characteristics of the LEDs will or will not be damaged by repairing.
- * The Die Heat Sink should be soldered to customer PCB.

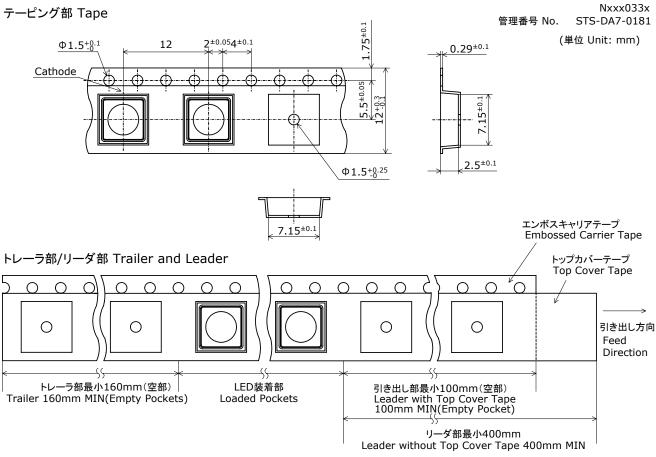
 If it is difficult or impossible, use high heat-dissipating adhesive.
- * When soldering, do not apply stress to the LED while the LED is hot.

PACKAGING - BULK

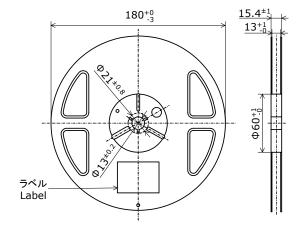


- * 本製品はICパックに入れたのち、輸送の衝撃から保護するためダンボールで梱包します。 Products shipped in anti-static *IC packs* are packed in a moisture-proof bag. They are shipped in cardboard boxes to protect them from external forces during transportation.
- * 取り扱いに際して、落下させたり、強い衝撃を与えたりしますと、製品を損傷させる原因になりますので注意して下さい。 Do not drop or shock the box. It may damage the products.
- * ダンボールには防水加工がされておりませんので、梱包箱が水に濡れないよう注意して下さい。 Do not expose to water, the box is not water-resistant.
- * 輸送、運搬に際して弊社よりの梱包状態あるいは同等の梱包を行って下さい。
 Using an original packaging material or equivalent in transit is recommended.

TAPE AND REEL DIMENSIONS

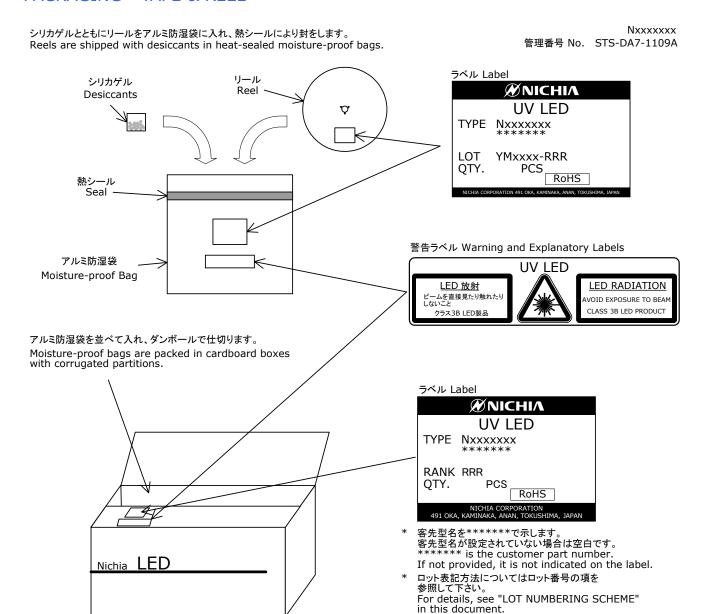


リール部 Reel



- * 数量は1リールにつき 500個入りです。 Quantity per reel=500pcs
- * JIS C 0806電子部品テーピングに準拠しています。
 The tape packing method complies with JIS C 0806
 (Packaging of Electronic Components on Continuous Tapes).

PACKAGING - TAPE & REEL



- * 本製品はテーピングしたのち、輸送の衝撃から保護するためダンボールで梱包します。
 Products shipped on tape and reel are packed in a moisture-proof bag.
 They are shipped in cardboard boxes to protect them from external forces during transportation.
- * 取り扱いに際して、落下させたり、強い衝撃を与えたりしますと、製品を損傷させる原因になりますので注意して下さい。 Do not drop or shock the box. It may damage the products.
- * ダンボールには防水加工がされておりませんので、梱包箱が水に濡れないよう注意して下さい。 Do not expose to water, the box is not water-resistant.
- * 輸送、運搬に際して弊社よりの梱包状態あるいは同等の梱包を行って下さい。
 Using an original packaging material or equivalent in transit is recommended.

LOT NUMBERING SCHEME

Lot Number is presented by using the following alphanumeric code.

YMxxxx - RRR

Y - Year

Year	Υ
2009	9
2010	А
2011	В
2012	C
2013	D
2014	Е

M - Month

Month	М	Month	М
1	1	7	7
2	2	8	8
3	3	9	9
4	4	10	А
5	5	11	В
6	6	12	С

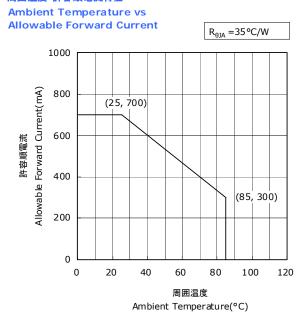
xxxx-Nichia's Product Number

RRR-Ranking by Wavelength, Ranking by Radiant Flux, Ranking by Forward Voltage

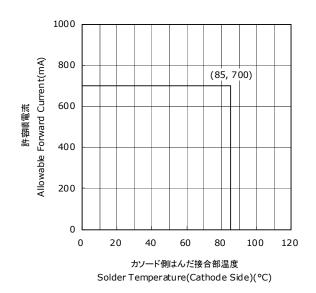
DERATING CHARACTERISTICS

NCSU033B 管理番号 No. STS-DA7-2588

周囲温度-許容順電流特性

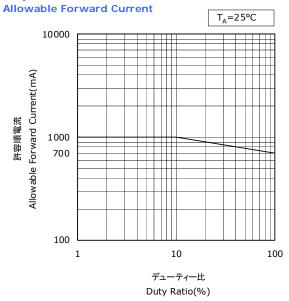


カソード側はんだ接合部温度-許容順電流特性 Solder Temperature(Cathode Side) vs Allowable Forward Current



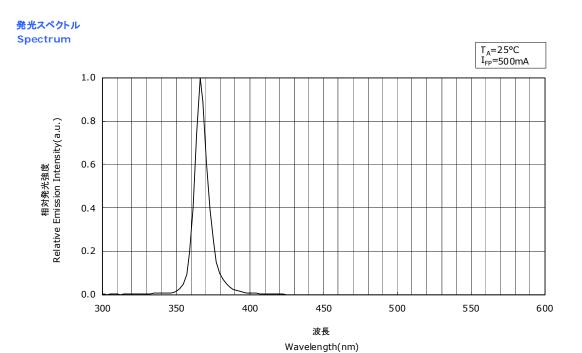
デューティー比-許容順電流特性

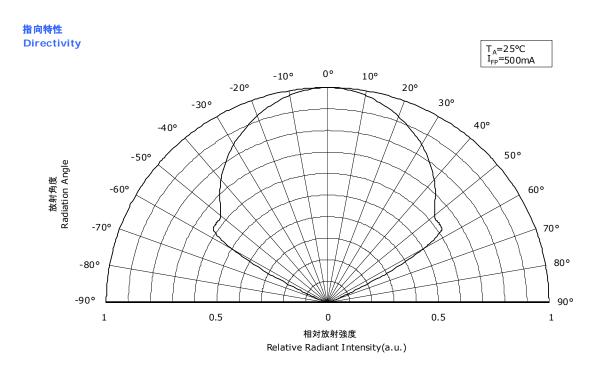




OPTICAL CHARACTERISTICS

* 本特性は参考です。 All characteristics shown are for reference only and are not guaranteed. NCSU033B 管理番号 No. STS-DA7-2589





FORWARD CURRENT CHARACTERISTICS / TEMPERATURE CHARACTERISTICS

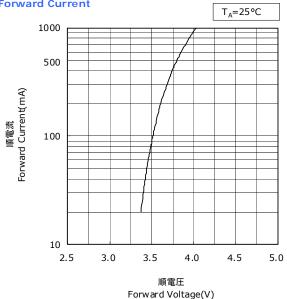
* 本特性は参考です。

All characteristics shown are for reference only and are not guaranteed.

NCSU033B 管理番号 No. STS-DA7-2590

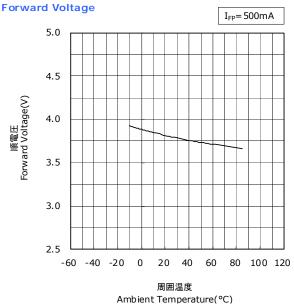
順電圧-順電流特性

Forward Voltage vs Forward Current



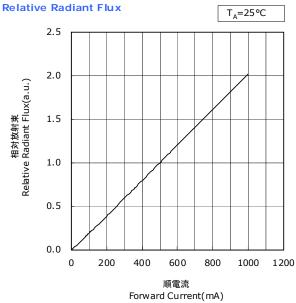
周囲温度-順電圧特性

Ambient Temperature vs



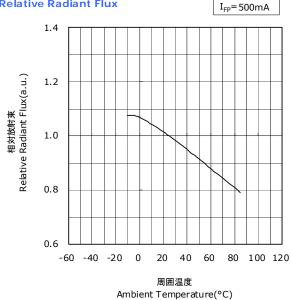
順電流-相対放射東特性

Forward Current vs



周囲温度-相対放射東特性

Ambient Temperature vs Relative Radiant Flux



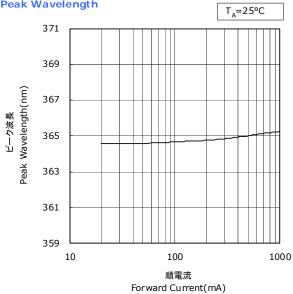
FORWARD CURRENT CHARACTERISTICS / TEMPERATURE CHARACTERISTICS

* 本特性は参考です。 All characteristics shown are for reference only and are not guaranteed.

NCSU033B 管理番号 No. STS-DA7-2591

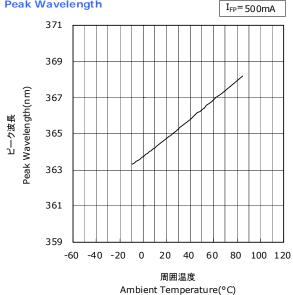


Forward Current vs Peak Wavelength 371



周囲温度-ピーク波長特性

Ambient Temperature vs Peak Wavelength



RELIABILITY

(1) Tests and Results

Test	Reference Standard	Test Conditions	Test Duration	Failure Criteria #	Units Failed/Tested
Resistance to Soldering Heat (Reflow Soldering)		T _{sld} =260°C, 10sec, 2reflows		#1	0/10
Temperature Cycle	JEITA ED-4701 100 105	-40°C(30min)~25°C(5min)~ 100°C(30min)~25°C(5min)	100cycles	#1	0/10
High Temperature Storage	JEITA ED-4701 200 201	T _A =100°C	1000hours	#1	0/10
Low Temperature Storage	JEITA ED-4701 200 202	T _A =-40°C	1000hours	#1	0/10
Room Temperature Operating Life Condition 1		T _A =25°C, I _F =500mA	1000hours	#1	0/10
Room Temperature Operating Life Condition 2		T _A =25°C, I _F =700mA	1000hours	#1	0/10
High Temperature Operating Life		T _A =85°C, I _F =300mA	1000hours	#1	0/10
Temperature Humidity Operating Life		60°C, RH=90%, I _F =450mA	500hours	#1	0/10
Low Temperature Operating Life		T _A =-10°C, I _F =500mA	1000hours	#1	0/10
Vibration	JEITA ED-4701 400 403	200m/s², 100~2000~100Hz, 4cycles, 4min, each X, Y, Z	48minutes	#1	0/10
Electrostatic Discharges	JEITA ED-4701 300 304	HBM, $2kV$, $1.5k\Omega$, $100pF$, $3pulses$, alternately positive or negative		#1	0/10

NOTES:

- 1) R_{θJA}≈35°C/W
- 2) Measurements are performed after allowing the LEDs to return to room temperature.

(2) Failure Criteria

Criteria #	Items	Conditions	Failure Criteria
	Forward Voltage(V _F)	I _F =500mA	>Initial value×1.1
#1	Radiant Flux(Φ_E)	I _F =500mA	<initial td="" value×0.7<=""></initial>

CAUTIONS

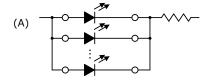
(1) Storage

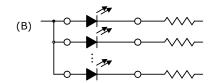
	Conditions	Temperature	Humidity	Time
Storage	Before Opening Aluminum Bag	≤30°C	≤90%RH	Within 1 Year from Delivery Date

- Absorbed moisture in LED packages can vaporize and expand during soldering, which can cause interface delamination
 and result in optical performance degradation. Products are packed in moisture-proof aluminum bags
 to minimize moisture absorption during transportation and storage.
 Included silica gel desiccants change from blue to red if moisture had penetrated bags.
- Although the leads or electrode pads (anode and cathode) of the product are plated with gold, prolonged exposure to a corrosive environment might cause the gold plated the leads or electrode pads to tarnish, and thus leading to difficulties in soldering. If unused LEDs remain, they must be stored in a hermetically sealed container. Nichia recommends using the original moisture-proof bag for storage.
- Do not use sulfur-containing materials in commercial products. Some materials, such as seals and adhesives, may contain sulfur. The contaminated plating of LEDs might cause an open circuit. Silicone rubber is recommended as a material for seals. Bear in mind, the use of silicones may lead to silicone contamination of electrical contacts inside the products, caused by low molecular weight volatile siloxane.
- To prevent water condensation, please avoid large temperature and humidity fluctuations for the storage conditions.

(2) Directions for Use

When designing a circuit, the current through each LED must not exceed the Absolute Maximum Rating.
 Operating at a constant current per LED is recommended. In case of operating at a constant voltage, Circuit B is recommended.
 If the LEDs are operated with constant voltage using Circuit A, the current through the LEDs may vary due to the variation in Forward Voltage characteristics of the LEDs.





- LEDs should be operated in forward bias. Driving circuits must not subject LEDs to either forward or reverse voltage while off. Continuous reverse voltage can cause migration and LED damage.
- For stabilizing the LED characteristics, it is recommended to operate at greater than 10% nominal current.
- For outdoor use, necessary measures should be taken to prevent water, moisture and salt air damage.
- This LED also emits visible light. Please take notice of visible light spectrum, in case you use this LED as light source of sensors etc.

(3) Handling Precautions

- Do not handle LEDs with bare hands, it may contaminate the LED surface and affect optical characteristics.

 In the worst case, catastrophic failure from excess pressure through wire-bond breaks and package damage may result.
- When handling the product with tweezers, be careful not to apply excessive force to the resin.

 Otherwise, The resin can be cut, chipped, delaminate or deformed, causing wire-bond breaks and catastrophic failures.
- Dropping the product may cause damage.
- Do not stack assembled PCBs together. Failure to comply can cause the resin portion of the product to be cut, chipped, delaminated and/or deformed. It may cause wire to break, leading to catastrophic failures.

(4) Design Consideration

- Although Nichia recommends using a copper PCB for this product, customer is advised to verify the PCB with the products before use. Stress during soldering can cause the glass lens to break and/or the solder joints to crack.
- PCB warpage after mounting the products onto a PCB can cause the package to break.

The LED should be placed in a way to minimize the stress on the LEDs due to PCB bow and twist.

- The position and orientation of the LEDs affect how much mechanical stress is exerted on the LEDs placed near the score lines.

 The LED should be placed in a way to minimize the stress on the LEDs due to board flexing.
- Board separation must be performed using special jigs, not using hands.
- If an aluminum PCB is used, customer is advised to verity the PCB with the products before use.

 Thermal stress during use can cause the solder joints to crack.

(5) Electrostatic Discharge (ESD)

• The products are sensitive to static electricity or surge voltage. ESD can damage a die and its reliability.

When handling the products, the following measures against electrostatic discharge are strongly recommended:

Eliminating the charge

Grounded wriststrap, ESD footwear, clothes, and floors

Grounded workstation equipment and tools

ESD table/shelf mat made of conductive materials

Proper grounding is required for all devices, equipment, and machinery used in product assembly.
 Surge protection should be considered when designing of commercial products.

• If tools or equipment contain insulating materials such as glass or plastic,

the following measures against electrostatic discharge are strongly recommended:

Dissipating static charge with conductive materials

Preventing charge generation with moisture

Neutralizing the charge with ionizers

The customer is advised to check if the LEDs are damaged by ESD
when performing the characteristics inspection of the LEDs in the application.

Damage can be detected with a forward voltage measurement at low current (≤1mA).

• ESD damaged LEDs may have current flow at a low voltage.

Failure Criteria: V_F <2.0V at I_F =0.5mA

(6) Thermal Management

- Proper thermal management is an important when designing products with LEDs. LED die temperature is affected by PCB thermal resistance and LED spacing on the board. Please design products in a way that the LED die temperature does not exceed the maximum Junction Temperature (T_J).
- Drive current should be determined for the surrounding ambient temperature (T_A) to dissipate the heat from the product.
- The following equations can be used to calculate the junction temperature of the products.

1)
$$T_J = T_A + R_{\theta JA} \cdot W$$
 2) $T_J = T_S + R_{\theta JS} \cdot W$

*T_J=LED junction temperature: °C

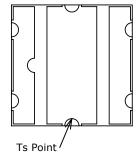
 $T_A {=} Ambient \ temperature: \ ^{\circ}C$

T_S=Soldering temperature (cathode side): °C

 $R_{\theta JA}$ =Thermal resistance from junction to ambient: °C/W

 $R_{\text{0JS}}\text{=}Thermal resistance from junction to }T_{S}\text{ measuring point}\text{\approx}7^{\circ}\text{C/W}$

 $W=Input power(I_F \times V_F)$: W



(7) Cleaning

- The LEDs should not be cleaned. Other cleaning agents except for Freon solvent should be tested prior to use whether they will not affect the package and the glass. Please note that Freon solvent is prohibited worldwide.
- Ultrasonic cleaning is not recommended since it may have adverse effects on the LEDs depending on the ultrasonic power and how LED is assembled.
 - If ultrasonic cleaning must be used, the customer is advised to make sure the LEDs will not be damaged prior to cleaning.

(8) Eye Safety

- In 2006, the International Electrical Commission (IEC) published IEC 62471:2006 Photobiological safety of lamps and lamp systems, which added LEDs in its scope.
- On the other hand, the IEC 60825-1:2007 laser safety standard removed LEDs from its scope.
- However, please be advised that some countries and regions have adopted standards
- based on the IEC laser safety standard IEC 60825-1:20112001, which still includes LEDs in its scope.
- Most of Nichia's LEDs can be classified as belonging into either the Exempt Group or Risk Group 1.
- High-power LEDs, that emit light containing blue wavelengths, may be classified as Risk Group 2.
- Please proceed with caution when viewing directly any LEDs driven at high current, or viewing LEDs with optical instruments which may greatly increase the damages to your eyes.
- Viewing a flashing light may cause eye discomfort. When incorporating the LED into your product, please be careful to avoid adverse effects on the human body caused by light stimulation.
- The products are UV light LEDs, and radiate intense UV light during operation. Since UV light can be harmful to eyes, do NOT look directly into the UV light, even through an optical instrument. In case of the light reflection, UV protective glasses are required to use in order to avoid damage by the light.

(9) Others

- The LEDs described in this brochure are intended to be used for ordinary electronic equipment (such as office equipment, communications equipment, measurement instruments and household appliances).
 Consult Nichia's sales staff in advance for information on the applications in which exceptional quality and reliability are required, particularly when the failure or malfunction of the LEDs may directly jeopardize life or health (such as for airplanes, aerospace, submersible repeaters, nuclear reactor control system, automobiles, traffic control equipment, life support systems and safety devices).
- The customer shall not reverse engineer by disassembling or analysis of the LEDs without having prior written consent from Nichia. When defective LEDs are found, the customer shall inform Nichia directly before disassembling or analysis.
- Both the customers and Nichia will agree on official specifications of supplied products before a customer's volume production.
- Specifications and appearance subject to change for improvement without notice.